

Material: 3879817 Hyper pure Silicon Wafers

(polished, epitaxial and non polished)

Version: 1.10 (GB) Date of print: 25.08.2020 Date of last alteration: 24.08.2020

SECTION 1: Identification of the substance/mixture and of the company/undertaking

1.1 Product identifier

Commercial product name: Hyper pure Silicon Wafers

(polished, epitaxial and non polished)

CAS No.: 7440-21-3 EC-No.: 231-130-8

REACH registration number: 01-2119480401-47-0220

1.2 Relevant identified uses of the substance or mixture and uses advised against

Use of substance / preparation:

Industrial. electronic

1.3 Details of the supplier of the safety data sheet

Manufacturer/distributor: Siltronic AG

 Street/POB-No.:
 Johannes-Hess-Straße 24

 State/postal code/city:
 D 84489 Burghausen

 Telephone:
 +49 8677 83-3930

 Telefax:
 +49 8677 83-62171

Information about the Safety Data Sheet: Telephone +49 8677 83-4888 Telefax +49 8677 886-9722

eMail #49 60 / 7 600-9722 eMail WLCP-MSDS@wacker.com

1.4 Emergency telephone number

Emergency Information (German): Plant fire brigade +49 8677 83-2222 Emergency Information (internat.): National Response Center +49 621 60-43333

SECTION 2: Hazards identification

2.1 Classification of the substance or mixture

Classification according to Regulation (EC) No. 1272/2008:

Not a hazardous substance or mixture.

2.2 Label elements

Labelling according to Regulation (EC) No. 1272/2008:

No labeling according to GHS required.

EC-No.: 231-130-8 Other hazards

No data available.

SECTION 3: Composition/information on ingredients

3.1 Substances

2.3

3.1.1 Chemical characteristics

CAS No.: 7440-21-3

Silicon

3.1.2 Hazardous ingredients



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This material does not contain any ingredients above the permitted limit(s).

This product does not contain substances of very high concern (Regulation (EC) No 1907/2006 (REACH), Article 57) in amounts above ≥ 0.1%.

3.2 Mixtures

not applicable

SECTION 4: First aid measures

4.1 Description of first aid measures

General information:

No special measures required.

After contact with the eyes:

Rinse immediately with plenty of water for 10-15 minutes and seek medical advice.

After contact with the skin:

No special measures required.

After inhalation:

In case of dust formation: Provide fresh air.

After swallowing:

No special measures required. In cases of sickness seek medical advice (show label if possible).

4.2 Most important symptoms and effects, both acute and delayed

Any relevant information can be found in other parts of this section.

4.3 Indication of any immediate medical attention and special treatment needed

Further toxicology information in section 11 must be observed.

SECTION 5: Firefighting measures

5.1 Extinguishing media

Suitable extinguishing media:

Use extinguishing measures appropriate to the source of fire.

Extinguishing media which must not be used for safety reasons:

not applicable

5.2 Special hazards arising from the substance or mixture

Hazardous combustion products: silicon dioxide .

5.3 Advice for firefighters

Special protective equipment for fire fighting:

Use respiratory protection independent of recirculated air. Use tightly fitting chemical protection suit (see section 8).

SECTION 6: Accidental release measures

6.1 Personal precautions, protective equipment and emergency procedures

Wear personal protection equipment (see section 8).

6.2 Environmental precautions

Observe local/state/federal regulations.

6.3 Methods and material for containment and cleaning up

Take up mechanically and dispose of according to local/state/federal regulations.



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6.4 Reference to other sections

Relevant information in other sections has to be considered. This applies in particular for information given on personal protective equipment (section 8) and on disposal (section 13).

SECTION 7: Handling and storage

7.1 Precautions for safe handling

Precautions for safe handling:

Keep container closed when not in use. Keep away from incompatible substances in accordance with section 10.

Precautions against fire and explosion:

Observe the general rules for fire prevention. Product can separate hydrogen in contact with lyes.

7.2 Conditions for safe storage, including any incompatibilities

Conditions for storage rooms and vessels:

Observe local/state/federal regulations. Protect against moisture.

Advice for storage of incompatible materials:

Keep away from alkalis. Avoid contact with acids.

Further information for storage:

Protect against moisture.

7.3 Specific end use(s)

No data available.

SECTION 8: Exposure controls/personal protection

8.1 Control parameters

Maximum airborne concentrations at the workplace:

not applicable

Predicted No Effect Concentration (PNEC):

silicon

••	
Area of use:	Value:
Intermittent release	100 mg/l
sewage treatment plant	25 mg/l

8.2 Exposure controls

8.2.1 Exposure in the work place limited and controlled

General protection and hygiene measures:

Observe standard industrial hygiene practices for the handling of chemical substances. Avoid contact with eyes and skin. Do not eat, drink or smoke when handling. Wash hands at the end of work and before eating.

Personal protection equipment:

Respiratory protection

No personal respiratory protective equipment normally required.

Respirator must be worn if exposed to dust. Suitable respiratory equipment: Filtering half-face mask, according to acknowledged standards such as EN 149.

Recommended Filter type: FFP1 or equivalent filter, according to acknowledged standards such as EN 149

Eye protection

In case of mechanical handling: tight fitting protective goggles.

Hand protection



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Use of protective gloves is recommended when handling the material. For the choice of suitable gloves, workplace conditions have to be considered, like e.g. handling of other substances and materials.

Method:

Recommended glove types: Protective gloves, non-cuttable

Skin protection

Recommendation in case of dust formation: protective clothing.

SECTION 9: Physical and chemical properties

9.1 Information on basic physical and chemical properties

Property:	Value:		
Appearance	10-4		
Physical state	solid		
Form			
Colour	Silvei		
Odour	odourless		
Odour limit	ododness		
Odour limit:	no data available		
pH-Value			
pH-Value:	not applicable		
Melting point/freezing point			
Melting point / melting range	1410 °C		
Initial boiling point and boiling range			
Boiling point / boiling range:	2355 °C		
Flash point			
Flash point:	not applicable		
Evaporation rate			
Evaporation rate	no data available		
Upper/lower flammability or explosive limits			
Lower explosion limit (LEL)			
Upper explosion limit (UEL)	not applicable		
Vapour pressure			
Vapour pressure	not applicable		
Solubility(ies) Water solubility / miscibility	vietu allvi in aa lubla		
Value solubility / misciplifty Vapour density	virtually insoluble		
Relative gas/vapour density:	No data known		
Relative Density	NO data KITOWIT.		
Relative Density:	2,32		
Toldivo Bolloky	(Water / 4 °C = 1,00)		
Density:	2.32 g/cm ³		
Partition coefficient: n-octanol/water	_,o_ g,		
Partition coefficient: n-octanol/water:	No data known.		
Auto-ignition temperature			
Ignition temperature	not applicable		
Viscosity	• •		
Viscosity (dynamic)	not applicable		
Viscosity (kinematic)			
Molecular mass			
Molecular mass:	no data available		

9.2 Other information

No data available.



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SECTION 10: Stability and reactivity

10.1 - 10.3 Reactivity; Chemical stability; Possibility of hazardous reactions

If stored and handled in accordance with standard industrial practices no hazardous reactions are known.

Relevant information can possibly be found in other parts of this section.

10.4 Conditions to avoid

Moisture.

10.5 Incompatible materials

Reacts with: lyes . The reaction takes place with the formation of hydrogen. Reacts with: strong oxidizing agents , acids .

10.6 Hazardous decomposition products

If stored and handled properly: none known.

SECTION 11: Toxicological information

11.1 Information on toxicological effects

11.1.1 Acute toxicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.2 Skin corrosion/irritation

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.3 Serious eye damage / eye irritation

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.4 Respiratory or skin sensitization

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.5 Germ cell mutagenicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.6 Carcinogenicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.7 Reproductive toxicity

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.8 Specific target organ toxicity (single exposure)

Assessment:

For this endpoint no toxicological test data is available for the whole product.



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11.1.9 Specific target organ toxicity (repeated exposure)

Assessment:

For this endpoint no toxicological test data is available for the whole product.

11.1.10 Aspiration hazard

Assessment:

Based on the physical-chemical properties of the product no aspiration hazard must be expected.

11.1.11 Further toxicological information

By handling the product for many years no damage to health was observed.

SECTION 12: Ecological information

12.1 Toxicity

Assessment:

No expected damaging effects to aquatic organisms. According to current knowledge adverse effects on water purification plants are not expected.

12.2 Persistence and degradability

Assessment:

Insoluble in water. Separation by sedimentation.

12.3 Bioaccumulative potential

Assessment:

No adverse effects expected.

12.4 Mobility in soil

Assessment:

Insoluble in water.

12.5 Results of PBT and vPvB assessment

This product contains no relevant substances considered to be persistent, bioaccumulative and toxic (PBT) or very persistent and very bioaccumulative (vPvB).

12.6 Other adverse effects

none known

SECTION 13: Disposal considerations

13.1 Waste treatment methods

13.1.1 Material

Recommendation:

Observe local/state/federal regulations.

13.1.2 Uncleaned packaging

Recommendation:

Completely discharge containers (no tear drops, no powder rest, scraped carefully). Empty containers should be sent to an approved recycling facility.

13.1.3 Waste Disposal Legislation Ref.No.(EC)

It is not possible to determine a waste code for this product in accordance with the European Waste Catalogue (EWC) since it is only possible to classify it according to how it is used by the customer. The waste code is to be determined within the EU in liaison



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with the waste-disposal operator.

SECTION 14: Transport information

14.1 – 14.4 UN number; UN proper shipping name; Transport hazard class(es); Packing group

Road ADR:

Valuation Not regulated for transport

Railway RID:

Valuation Not regulated for transport

Transport by sea IMDG-Code:

Valuation Not regulated for transport

Air transport ICAO-TI/IATA-DGR:

Valuation Not regulated for transport

14.5 Environmental hazards

Hazardous to the environment: no

14.6 Special precautions for user

Relevant information in other sections has to be considered.

14.7 Transport in bulk according to Annex II of MARPOL and the IBC Code

Bulk transport in tankers is not intended.

SECTION 15: Regulatory information

15.1 Safety, health and environmental regulations/legislation specific for the substance or mixture

National and local regulations must be observed.

For information on labelling please refer to section 2 of this document.

Directive 2012/18/EU of the European Parliament and of the Council on the control of major-accident hazards involving dangerous substances (Seveso III):

Not applicable

Relevant regulations:

SI 2002/1689: CHIP Regulations 2002 SI 2002/2677: COSHH Regulations 2002

SI 1999/3242: Management of Health & Safety at Work Regulations 1999

Health & Safety at Work Act 1974

SI 1993/1643: Environmental Protection Act 1993 & Subsidiary Regulations.

Other national and local measures relating to the workplace, pollution control, environmental protection and waste control.

Other specifications, restrictions and prohibitions:

Regulation (EC) No 649/2012 of the European Parliament and the Council concerning the export and import of dangerous chemicals: Not applicable

15.2 Chemical safety assessment

For this product, a chemical safety assessment according to (EC) regulation 1907/2006 (REACH) has been carried out.

15.3 Details of international registration status

Relevant information about individual substance inventories, where available, is given below.



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	Australia:	AICS (Australian Inventory of Chemical Substances):
		This product is listed in, or complies with, the substance inventory.
	China	IECSC (Inventory of Existing Chemical Substances in China):
		This product is listed in, or complies with, the substance inventory.
	Canada	DSL (Domestic Substance List):
		This product is listed in, or complies with, the substance inventory.
	Philippines	PICCS (Philippine Inventory of Chemicals and Chemical Substances):
		This product is listed in, or complies with, the substance inventory.
	United States of America (USA)	TSCA (Toxic Substance Control Act Chemical Substance Inventory):
	` ,	All components of this product are listed as active or are in compliance with the
		substance inventory.
•	European Economic Area (EEA)	REACH (Regulation (EC) No 1907/2006):
	, ,	General note: the registration obligations for substances imported into the EEA or manufactured within the EEA by the supplier mentioned in section 1 are fulfilled by the said supplier. The registration obligations for substances imported into the EEA
	South Korea (Republic of Korea):	by customers or other downstream users must be fulfilled by the latter. AREC (Act on Registration and Evaluation of Chemicals; "K-REACH"): Please approach your regular WACKER contact for more detailed information.

SECTION 16: Other information

16.1 Material

The details in this document are based on the state of our knowledge at the time of revision. They do not constitute an assurance of the described product properties in terms of statutory warranty requirements.

The providing of this document to a recipient does not relieve the recipient of his or her responsibility toward compliance with all laws and stipulations applicable to the product. This applies in particular to the further sale or distribution of the product or substances or items containing the product, in other jurisdictions and with regard to the protection of third-party intellectual property rights. If the described product is processed or mixed with other substances or materials, the details stated in this document cannot be conferred to the resultant new product unless this has been expressly mentioned. If the product is repackaged, the recipient is obligated to additionally provide the required safety-related information.

16.2 Further information:

Commas appearing in numerical data denote a decimal point. Vertical lines in the left-hand margin indicate changes compared with the previous version. This version supersedes all previous versions.

- End of Safety Data Sheet -